

# UNISONIC TECHNOLOGIES CO., LTD

UTT5N15 **Preliminary POWER MOSFET** 

# 5A, 150V N-CHANNEL **POWER MOSFET**

#### DESCRIPTION

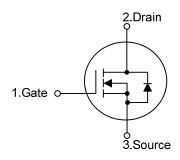
The UTC UTT5N15 is a N-channel mode power MOSFET using UTC's advanced technology to provide customers with a minimum on-state resistance, low gate charge and high switching speed.

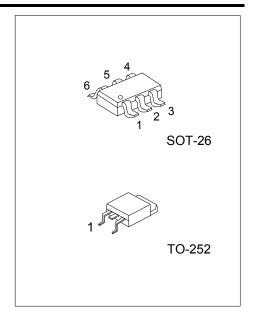
The UTC UTT5N15 is suitable for high voltage synchronous rectifier and AC/DC converters, etc.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 0.3 \Omega$  @  $V_{GS}$ =10V,  $I_D$ =2.5A
- \* High Switching Speed
- \* High Cell Density Trench Technology

#### **SYMBOL**





# **ORDERING INFORMATION**

Pin Assignment: G: Gate

Ordering Number		Daalaaaa	Pin Assignment			Daaliaa	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UTT5N15L-AG6-R	UTT5N15G-AG6-R	SOT-26	G	D	S	Tape Reel	
UTT5N15L-TN3-R	UTT5N15G-TN3-R	TO-252	G	D	S	Tape Reel	

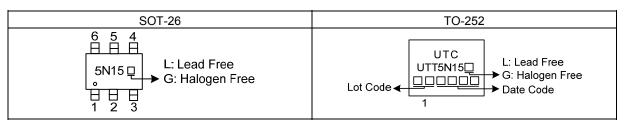
S: Source

D: Drain

UTT5N15G-TN3-R (1)Packing Type (1) R: Tape Reel (2) TN3: TO-252 (2)Package Type (3) G: Halogen Free and Lead Free, L: Lead Free (3)Green Package

#### **MARKING**

Note:



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# ■ **ABSOLUTE MAXIMUM RATING** (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V <sub>DSS</sub>	150	٧
Gate-Source Voltage		$V_{GSS}$	±20	٧
Drain Current (T <sub>C</sub> =25°C)	Continuous	I <sub>D</sub> 5		Α
	Pulsed (Note 2)	I <sub>DM</sub>	15	Α
Avalanche Energy (Note 3)	Single Pulsed (Note 3)	E <sub>AS</sub>	1.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.9	V/nS
Power Dissipation	SOT-26		1.3	W
	TO-252	P <sub>D</sub>	42	W
Junction Temperature		TJ	+150	°C
Storage Temperature Range		T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L=0.1mH,  $I_{AS}$ =5.6A,  $V_{DD}$ =50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 5.0 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ ,  $T_J \le 25 ^{\circ}C$

#### **■** THERMAL DATA (NOTE)

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-26	0	240	°C/W
	TO-252	$\theta_{JA}$	110	°C/W
lunation to Coop	SOT-26	0	96	°C/W
Junction to Case	TO-252	$\theta_{ extsf{JC}}$	2.9	°C/W

Note: Device mounted on FR-4 substrate Pc board, 2oz copper, with 1inch square copper plate.

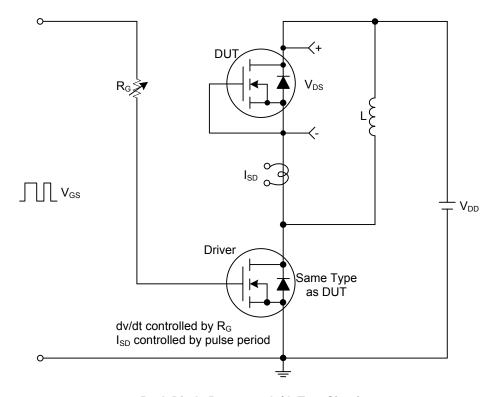
# ■ ELECTRICAL CHARACTERISTICS (T<sub>A</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS					•			
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V	150			V	
Drain-Source Leakage Current		$I_{DSS}$	V <sub>DS</sub> =150V, V <sub>GS</sub> =0V			10	μΑ	
Gate-Source Leakage Current	Forward		$V_{GS}$ =+20V, $V_{DS}$ =0V			+100	nA	
	Reverse	I <sub>GSS</sub>	V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2.5A			0.3	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		$C_{ISS}$			558.1		pF	
Output Capacitance		Coss	$V_{GS}$ =0V, $V_{DS}$ =25V, f=1.0MHz		44.8		pF	
Reverse Transfer Capacitance		$C_{RSS}$			25.4		pF	
SWITCHING PARAMETERS								
Total Gate Charge (Note 1)		$Q_G$	V <sub>DS</sub> =100V, V <sub>GS</sub> =10V,		19.7		nC	
Gate to Source Charge		$Q_GS$	I <sub>D</sub> =5.0A, I <sub>G</sub> =1mA		5.1		nC	
Gate to Drain Charge		$Q_GD$	(Note 1, 2)		4.4		nC	
Turn-on Delay Time (Note 1)		$t_{D(ON)}$	·// -100// // -10//		4.9		ns	
Rise Time		$t_R$	$V_{DD}$ =100V, $V_{GS}$ =10V, $I_{D}$ =5.0A, $R_{G}$ =6.0 $\Omega$		17		ns	
Turn-off Delay Time		$t_{D(OFF)}$	(Note 1, 2)		15		ns	
Fall-Time		$t_{F}$	(14010-1, 2)		17.3		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		Is				5	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				15	Α	
Drain-Source Diode Forward Voltage (Note 1)		$V_{\text{SD}}$	I <sub>S</sub> =5A, V <sub>GS</sub> =0V			1.4	V	
Reverse Recovery Time (Note 1)		t <sub>rr</sub>	I <sub>S</sub> =5A, V <sub>GS</sub> =0V,		57.9		nS	
Reverse Recovery Charge		$Q_{rr}$	dI/dt=100A/μs		248.5		nC	

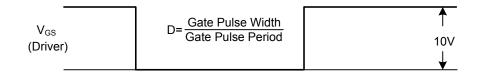
Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%.

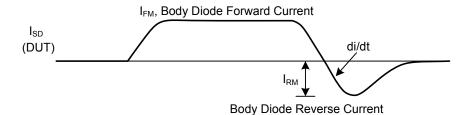
<sup>2.</sup> Essentially independent of operating temperature.

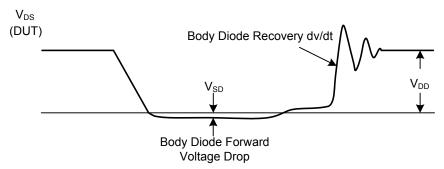
# **■ TEST CIRCUITS AND WAVEFORMS**



### Peak Diode Recovery dv/dt Test Circuit



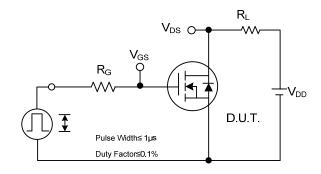


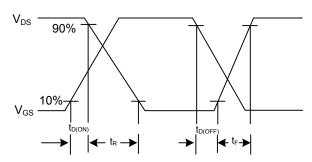


Peak Diode Recovery dv/dt Test Circuit and Waveforms

#### Peak Diode Recovery dv/dt Waveforms

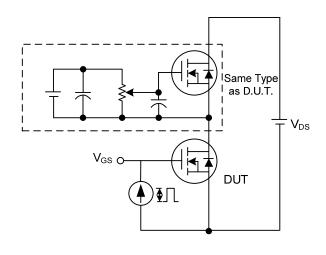
# **■ TEST CIRCUITS AND WAVEFORMS**

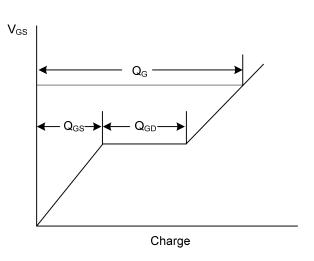




**Switching Test Circuit** 

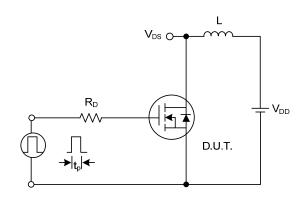
**Switching Waveforms** 

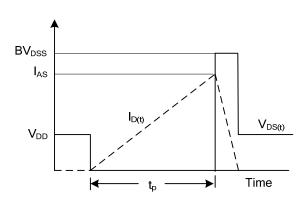




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

**Unclamped Inductive Switching Waveforms** 

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